

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
-60V	13mΩ@-10V	-80A
	16mΩ@-4.5V	

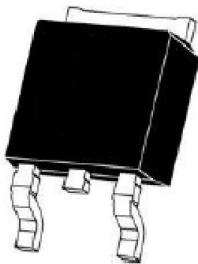
Feature

- Excellent gate charge x $R_{DS(on)}$ product(FOM)
- Very low on-resistance $R_{DS(on)}$
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

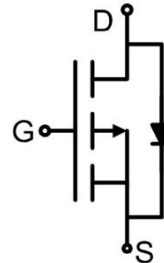
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Package

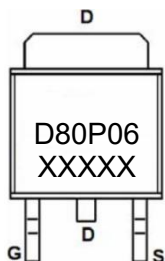


TO-252AB

Circuit diagram



Marking



Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	-60	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	-80	A
Continuous Drain Current(T _C =100 °C)	I _D (100 °C)	-58	A
Pulsed Drain Current	I _{DM}	-328	A
Power Dissipation	P _D	150	W
Thermal Resistance,Junction-to-Case	R _{θJC}	1.0	°C/W
Single pulse avalanche energy	E _{AS}	722	mJ
Junction Temperature	T _J	150	°C
Storage Temperature	T _{STG}	-55 ~ +150	°C

Electrical characteristics (T_A=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-60			V
Zero gate voltage drain current	I _{DSS}	V _{DS} = -60V, V _{GS} = 0V			-1	μA
Gate-body leakage current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1.2	-1.8	-2.4	V
Drain-source on-resistance ¹⁾	R _{DS(on)}	V _{GS} = -10V, I _D = -20A		11	13	mΩ
		V _{GS} = -4.5V, I _D = -20A		13	16	
Forward transconductance ¹⁾	g _{FS}	V _{DS} = -5V, I _D = -20A		25		S
Dynamic characteristics²⁾						
Input Capacitance	C _{iss}	V _{DS} = -30V, V _{GS} = 0V, f = 1MHz		5604		pF
Output Capacitance	C _{oss}			356		
Reverse Transfer Capacitance	C _{rss}			265		
Total Gate Charge	Q _g	V _{DS} = -30V, V _{GS} = -10V, I _D = -20A		62.1		nC
Gate-Source Charge	Q _{gs}			9.3		
Gate-Drain Charge	Q _{gd}			16.8		
Turn-on delay time	t _{d(on)}	V _{DD} = -30V, V _{GS} = -10V, R _L = 1.5Ω, R _{GEN} = 3Ω		18		nS
Turn-on rise time	t _r			20		
Turn-off delay time	t _{d(off)}			55		
Turn-off fall time	t _f			35		
Source-Drain Diode characteristics						
Diode Forward Current ¹⁾	I _S				-80	A
Diode Forward voltage	V _{DS}	V _{GS} = 0V, I _S = -20A			-1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = -20A		49		nS
Reverse Recovery Charge	Q _{rr}	di/dt = -100A/μs ¹⁾		71		nC

Notes:

- 1) Pulse Test: Pulse Width < 300μs, Duty Cycle ≤2%.
- 2) Guaranteed by design, not subject to production testing.

Typical Characteristics

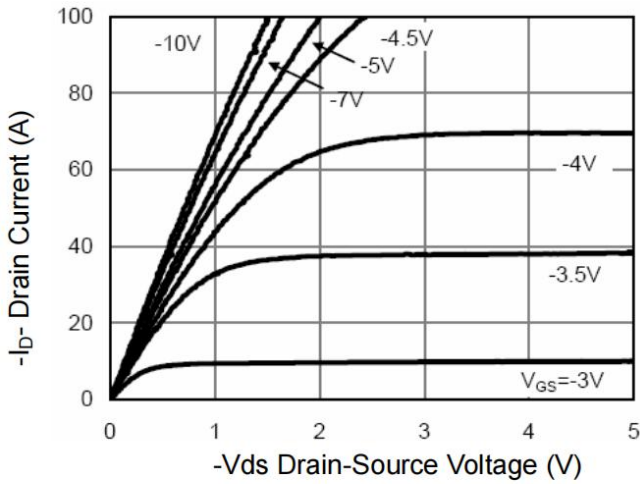


Figure 1 Output Characteristics

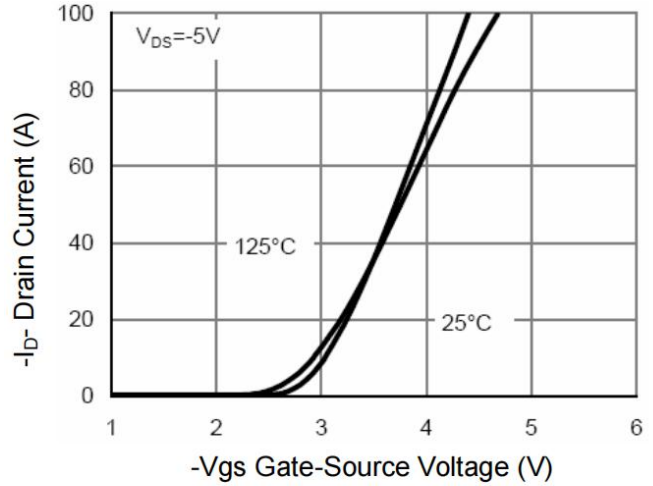


Figure 2 Transfer Characteristics

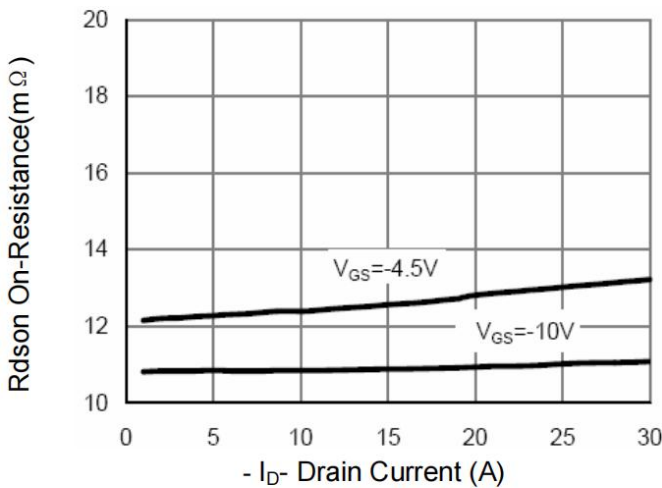


Figure 3 Rdson- Drain Current

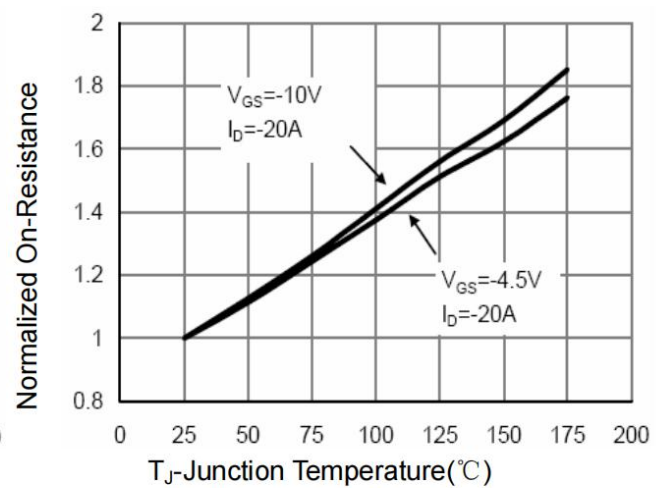


Figure 4 Rdson-Junction Temperature

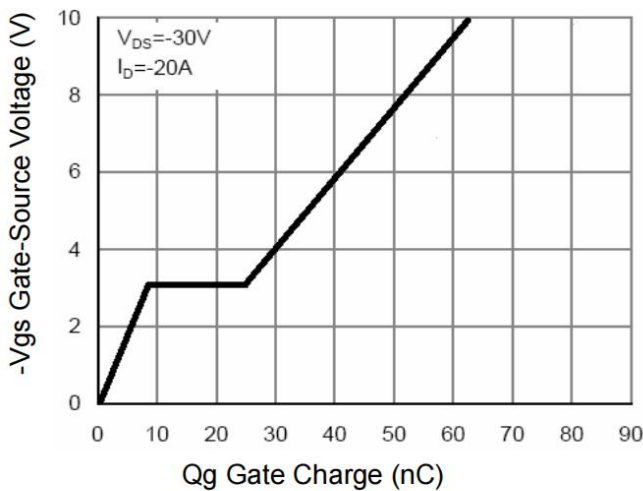


Figure 5 Gate Charge

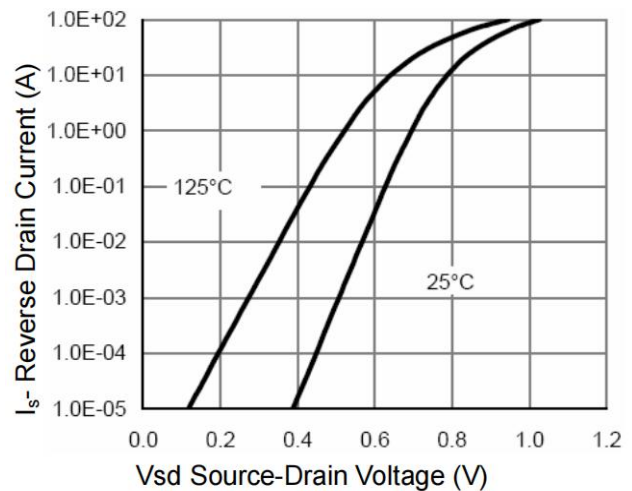


Figure 6 Source- Drain Diode Forward

Typical Characteristics

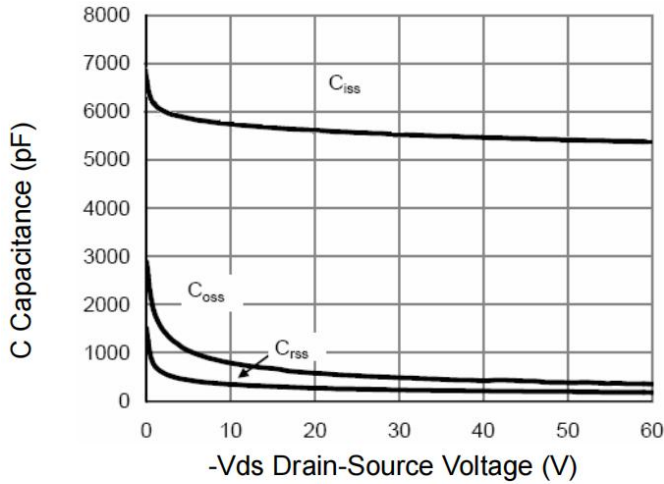


Figure 7 Capacitance vs Vds

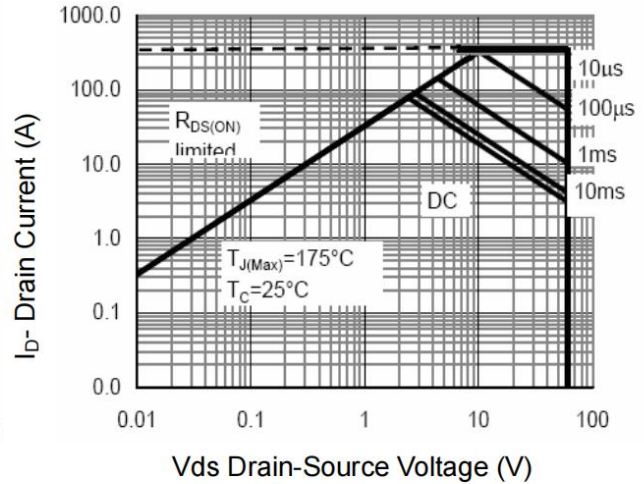


Figure 8 Safe Operation Area

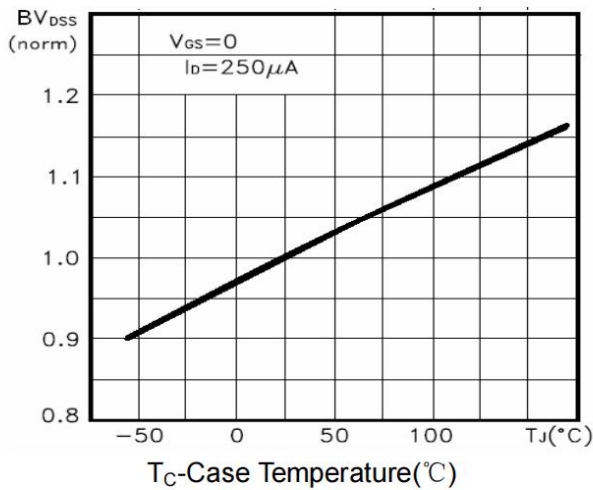


Figure 9 BV_{DSS} vs Junction Temperature

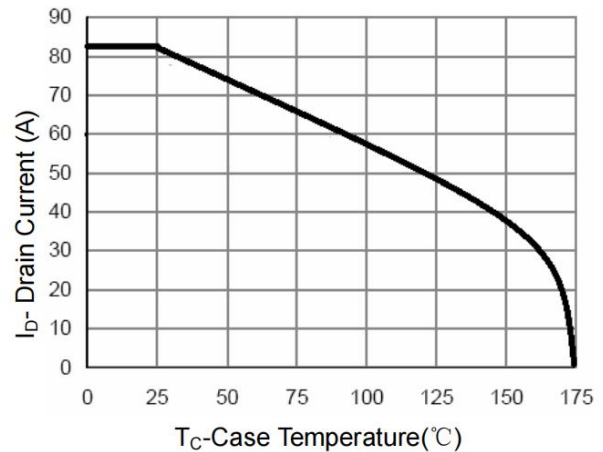


Figure 10 I_D Current Derating vs Junction Temperature

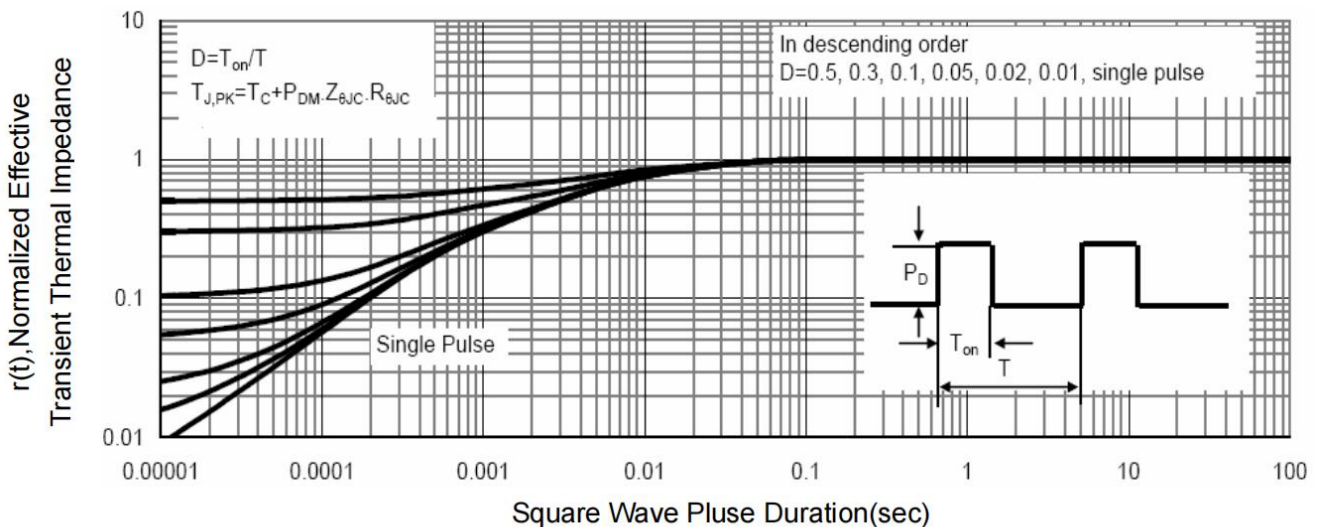
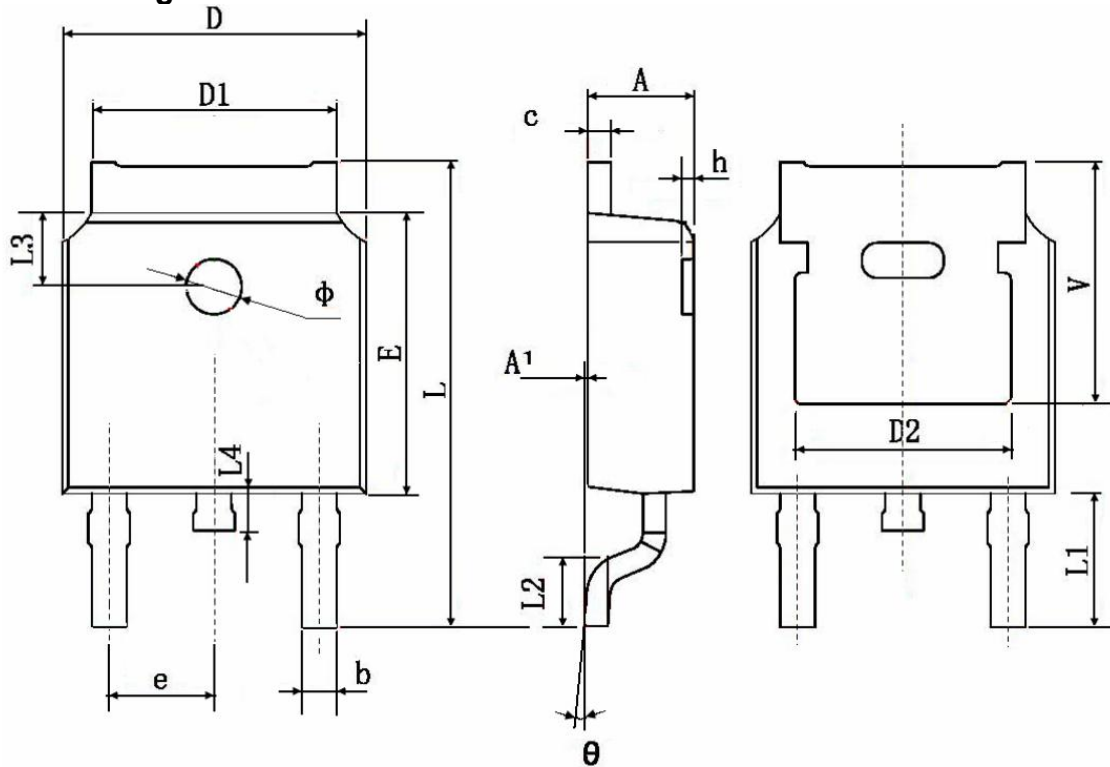


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-252AB Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	